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FDMC8321L

N-Channel Power Trench® MOSFET

40 V, 49 A, 2.5 mΩ

Features

- Max $r_{DS(on)}$ = 2.5 mΩ at $V_{GS} = 10$ V, $I_D = 22$ A
- Max $r_{DS(on)}$ = 4.1 mΩ at $V_{GS} = 4.5$ V, $I_D = 18$ A
- Advanced Package and Silicon combination for low $r_{DS(on)}$ and high efficiency
- Next Generation enhanced body diode technology, engineered for soft recovery
- 100% UIL tested
- RoHS Compliant



General Description

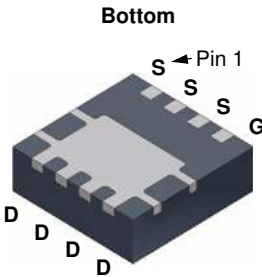
This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed body diode reverse recovery performance.

Applications

- Synchronous rectifier
- Load switch/Orring
- Motor switch

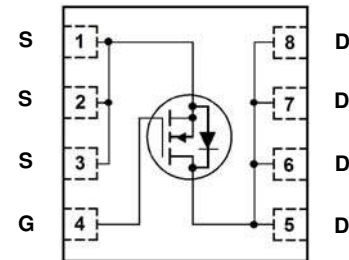


Top



Bottom

Power 33



MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Conditions	Rated Value	Units
V_{DS}	Drain to Source Voltage		40	V
V_{GS}	Gate to Source Voltage		±20	V
I_D	Drain Current	-Continuous $T_C = 25$ °C	49	A
		-Continuous $T_A = 25$ °C (Note 1a)	22	
		-Pulsed	100	
E_{AS}	Single Pulse Avalanche Energy	(Note 3)	86	mJ
P_D	Power Dissipation	$T_C = 25$ °C	40	W
	Power Dissipation	$T_A = 25$ °C (Note 1a)	2.3	
T_J, T_{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	3.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8321L	FDMC8321L	Power33	13 "	12 mm	3000 units

Electrical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250\text{ }\mu\text{A}$, $V_{GS} = 0\text{ V}$	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^\circ\text{C}$		22		mV/ $^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32\text{ V}$, $V_{GS} = 0\text{ V}$			1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{ V}$			± 100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250\text{ }\mu\text{A}$	1	1.7	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\text{ }\mu\text{A}$, referenced to $25\text{ }^\circ\text{C}$		-5		mV/ $^\circ\text{C}$
$r_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\text{ V}$, $I_D = 22\text{ A}$		1.9	2.5	m Ω
		$V_{GS} = 4.5\text{ V}$, $I_D = 18\text{ A}$		2.7	4.1	
		$V_{GS} = 10\text{ V}$, $I_D = 22\text{ A}$, $T_J = 125\text{ }^\circ\text{C}$		2.8	3.7	
g_{FS}	Forward Transconductance	$V_{DS} = 5\text{ V}$, $I_D = 22\text{ A}$		114		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 20\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$		2930	3900	pF
C_{oss}	Output Capacitance			1000	1330	pF
C_{rss}	Reverse Transfer Capacitance			60	90	pF
R_g	Gate Resistance		0.1	0.7	2.5	Ω

Switching Characteristics

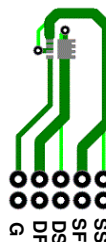
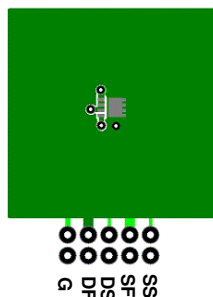
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 20\text{ V}$, $I_D = 22\text{ A}$, $V_{GS} = 10\text{ V}$, $R_{GEN} = 6\text{ }\Omega$		12	22	ns
t_r	Rise Time			6.1	12	ns
$t_{d(off)}$	Turn-Off Delay Time			32	51	ns
t_f	Fall Time			4.9	10	ns
$Q_{g(TOT)}$	Total Gate Charge at 10 V	$V_{DD} = 20\text{ V}$, $I_D = 22\text{ A}$		44	61	nC
$Q_{g(TOT)}$	Total Gate Charge at 5 V			21	32	nC
Q_{gs}	Total Gate Charge			7.7		nC
Q_{gd}	Gate to Drain "Miller" Charge			5.8		nC

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0\text{ V}$, $I_S = 2\text{ A}$ (Note 2)		0.69	1.2	V
		$V_{GS} = 0\text{ V}$, $I_S = 22\text{ A}$ (Note 2)		0.77	1.3	
t_{rr}	Reverse Recovery Time	$I_F = 22\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$		41	65	ns
Q_{rr}	Reverse Recovery Charge			20	33	nC

Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



2. Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0%.

3. Starting $T_J = 25\text{ }^\circ\text{C}$; N-ch: $L = 0.3\text{ mH}$, $I_{AS} = 24\text{ A}$, $V_{DD} = 36\text{ V}$, $V_{GS} = 10\text{ V}$.

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

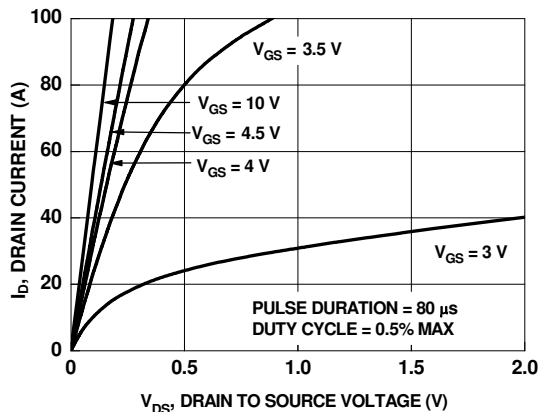


Figure 1. On Region Characteristics

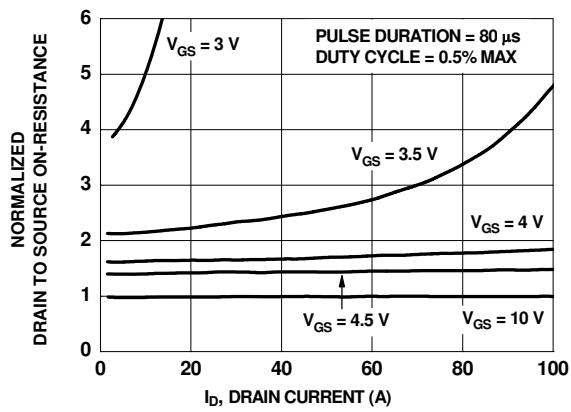


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

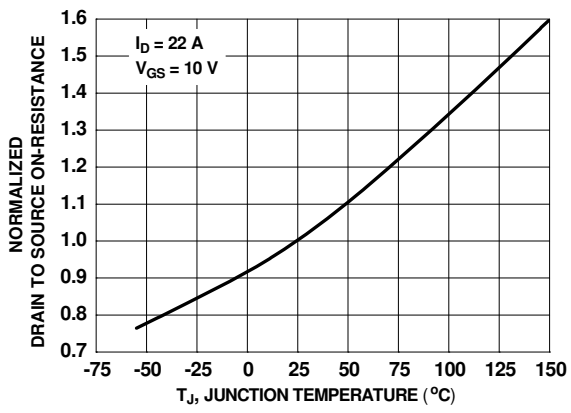


Figure 3. Normalized On Resistance vs Junction Temperature

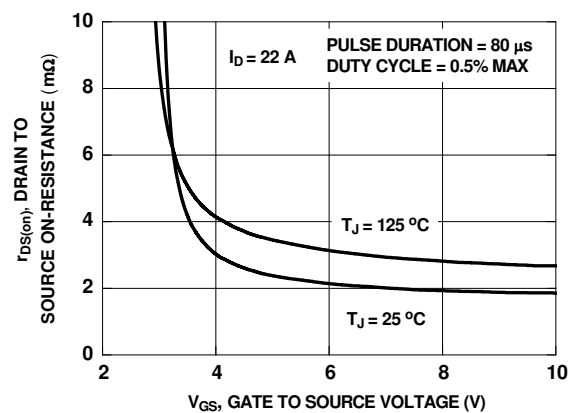


Figure 4. On-Resistance vs Gate to Source Voltage

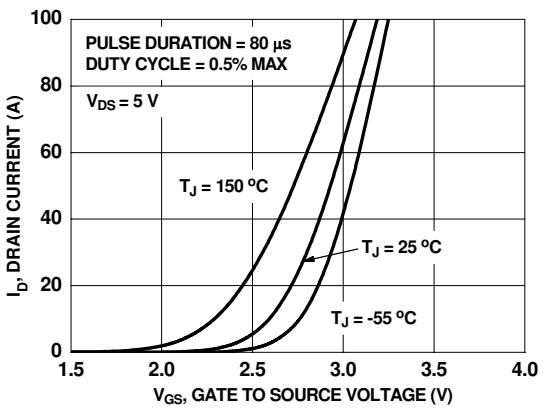


Figure 5. Transfer Characteristics

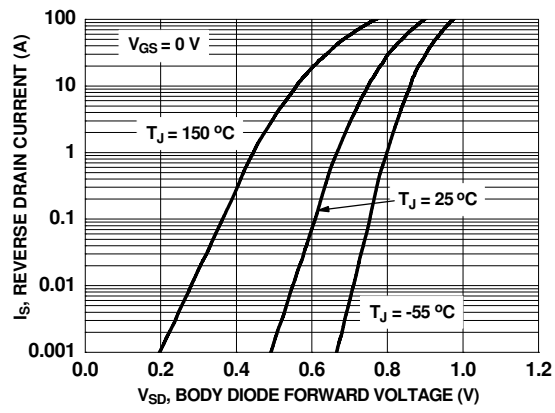


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

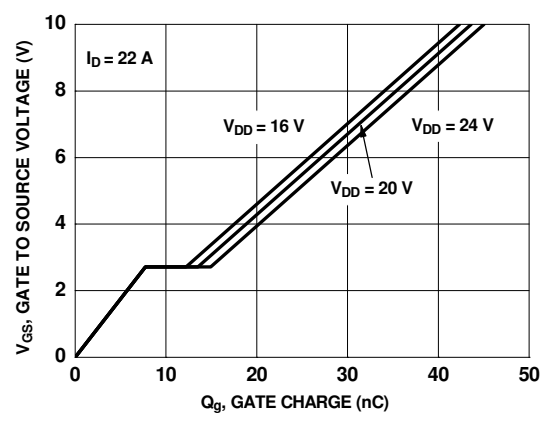


Figure 7. Gate Charge Characteristics

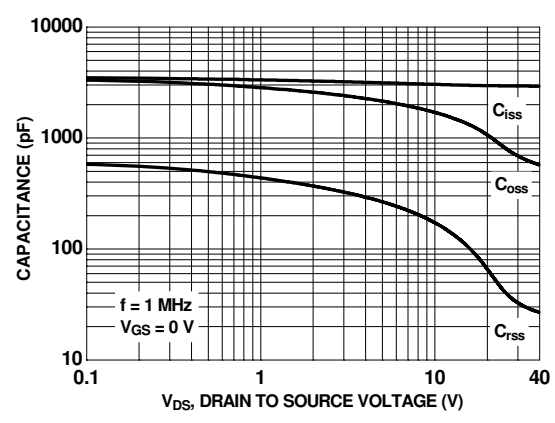


Figure 8. Capacitance vs Drain to Source Voltage

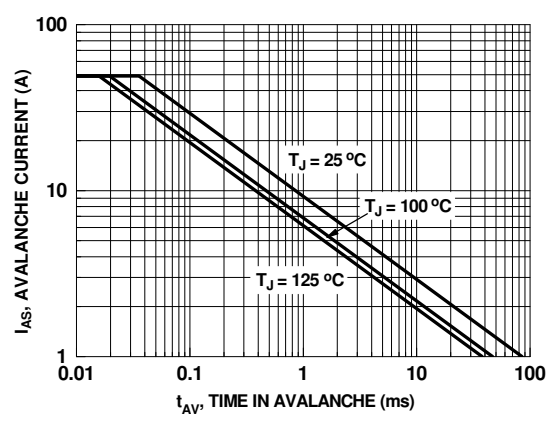


Figure 9. Unclamped Inductive Switching Capability

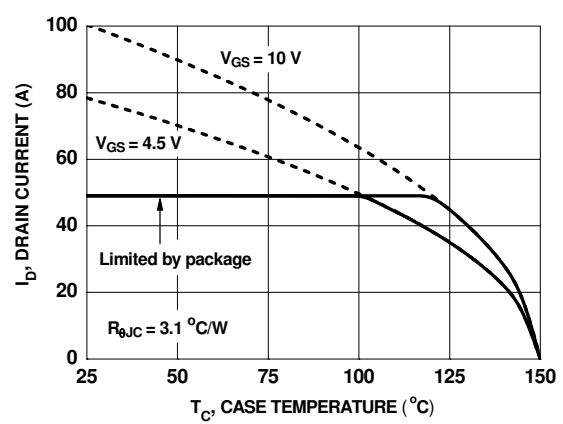


Figure 10. Maximum Continuous Drain Current vs Case Temperature

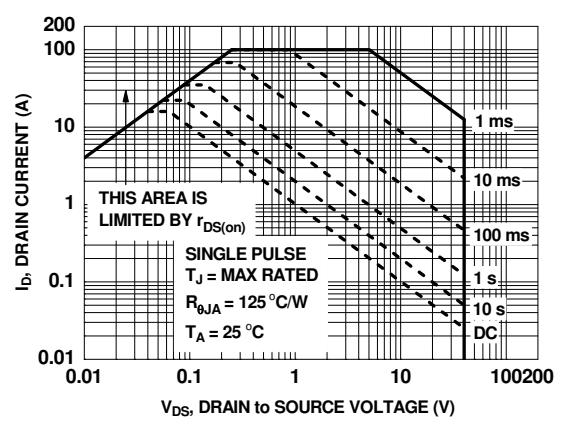


Figure 11. Forward Bias Safe Operating Area

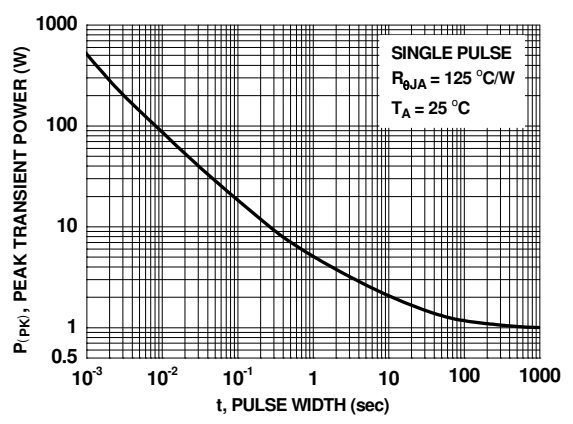


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted

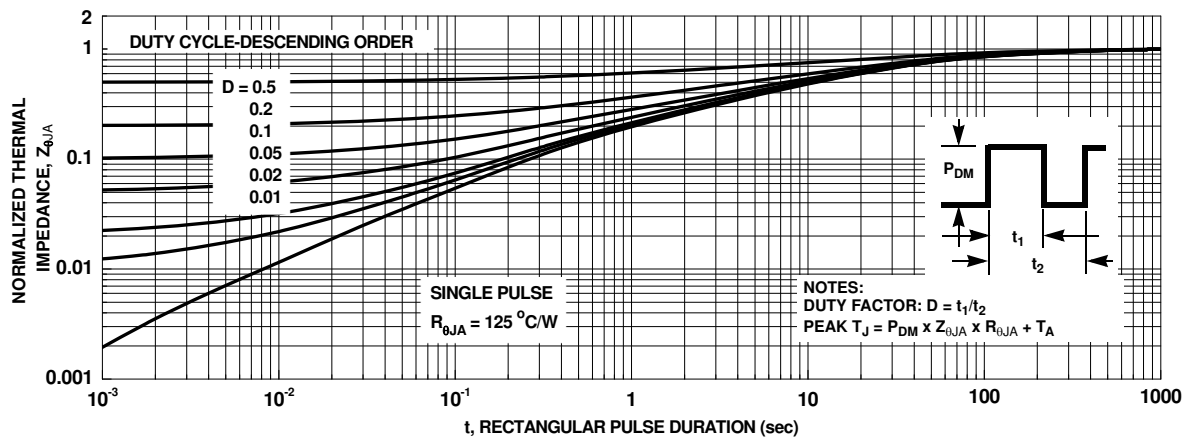
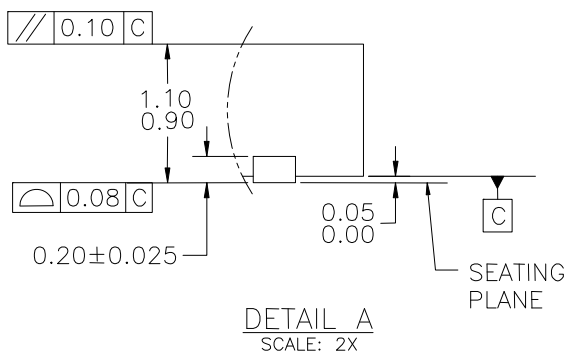
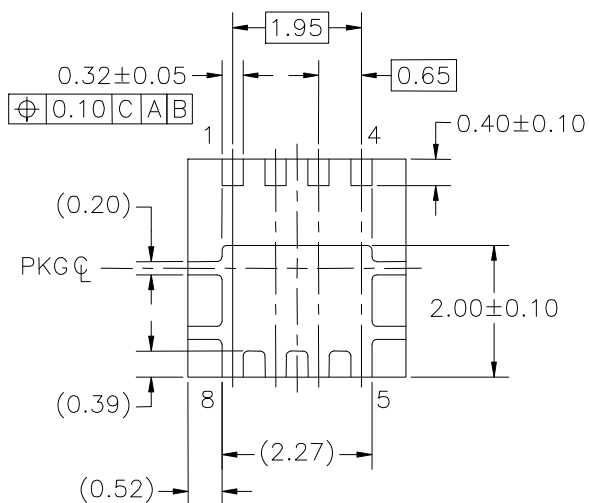
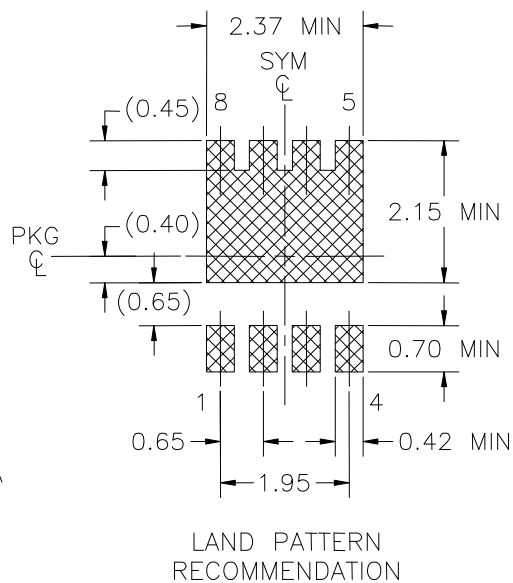
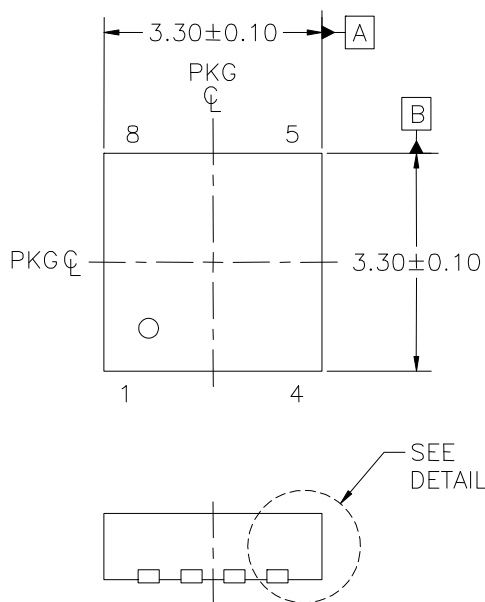


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

Dimensional Outline and Pad Layout



NOTES: UNLESS OTHERWISE SPECIFIED

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JEDEC MO-240, ISSUE A, VAR. BA,
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- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS
OR MOLD FLASH. MOLD FLASH OR
BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER
ASME Y14.5M-1994.
- E) DRAWING FILE NAME: PQFN08BREV1

PQFN08BREV1



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